HD74AC166/HD74ACT166

8-bit Shift Register

HITACHI

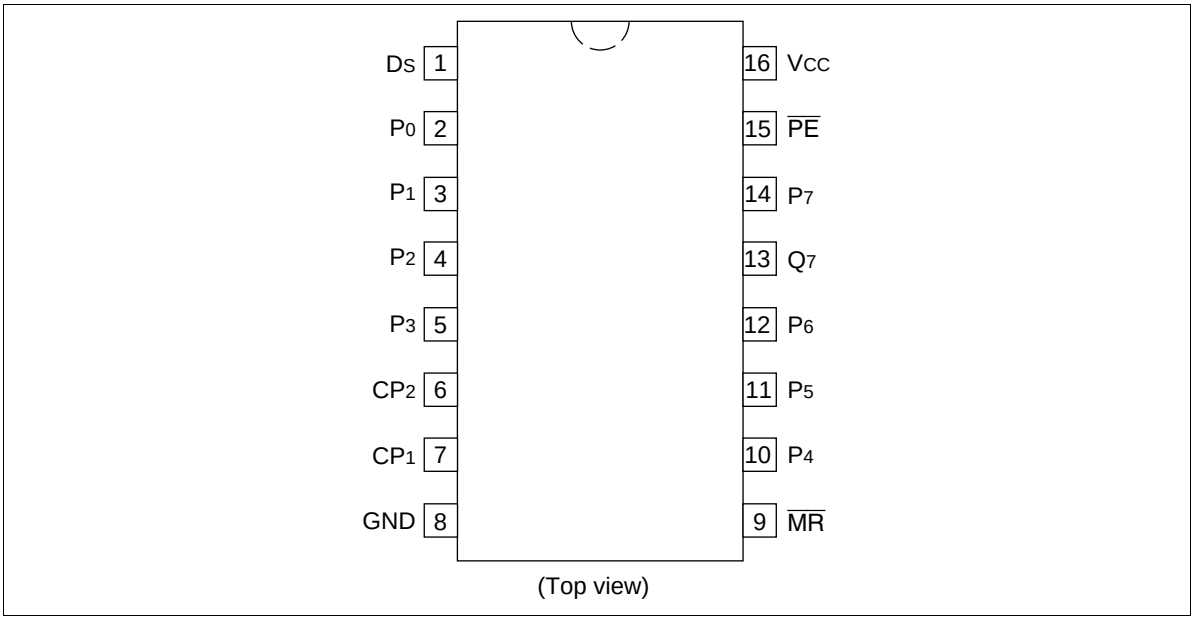
Description

The HD74AC166/HD74ACT166 is an 8-bit, serial or parallel-in, serial-out shift register using edge triggered D-type flip-flops. Serial and parallel entry are synchronous, with state changes initiated by the rising edge of the clock. An asynchronous Master Reset overrides other inputs and clears all flip-flops. The circuit can be clocked from two sources or one CP input can be used to trigger the other.

Features

- Outputs Source/Sink 24 mA
- HD74ACT166 has TTL-Compatible Inputs

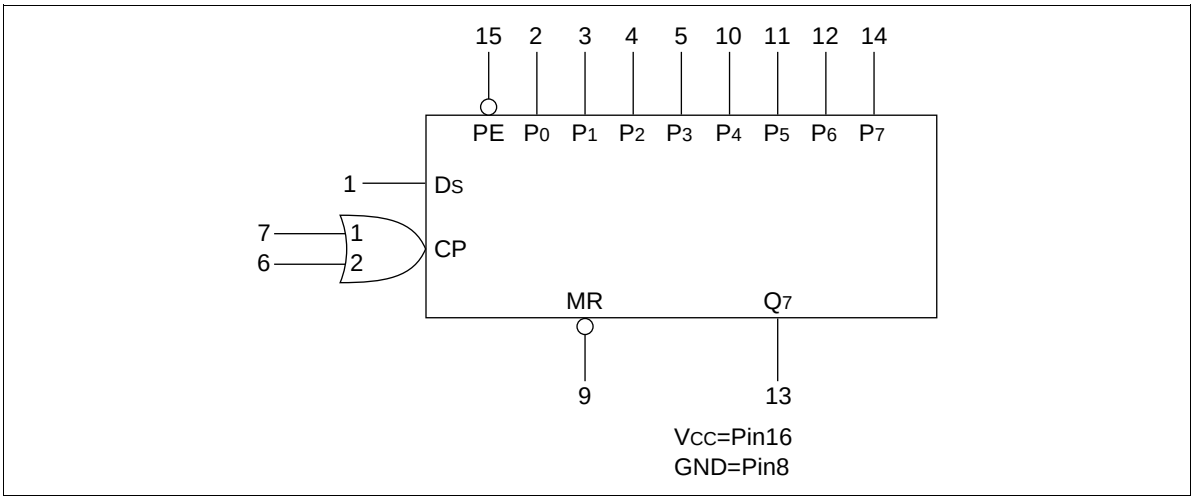
Pin Arrangement



(Top view)

Hitachi semiconductor

Logic Symbol



Pin Names

CP_1, CP_2	Clock Pulse Inputs (Active Rising Edge)
D_S	Serial Data Input
$\overline{PE}$	Parallel Enable Input (Active Low)
P_0 to P_7	Parallel Data Inputs
$\overline{MR}$	Asynchronous Master Reset Input (Active Low)
Q_7	Last Stage Output

Functional Description

Operation is synchronous (except for Master Reset) and state changes are initiated by the rising edge of either clock input if the other clock input is Low. When one of the clock inputs is used as an active High clock inhibt, it should attain the High state while the other clock is still in the High state following the previous operation. When the Parallel Enable ($\overline{PE}$) input is Low, data is loaded into the register from the Parallel Data (P_0 to P_7) inputs on the next rising edge of the clock. When $\overline{PE}$ is High, information is shifted from the Serial Data (D_S) input to Q_0 and all data in the register is shifted one bit position (i.e., $Q_0 \rightarrow Q_1$, $Q_1 \rightarrow Q_2$, etc.) on the rising edge of the clock.

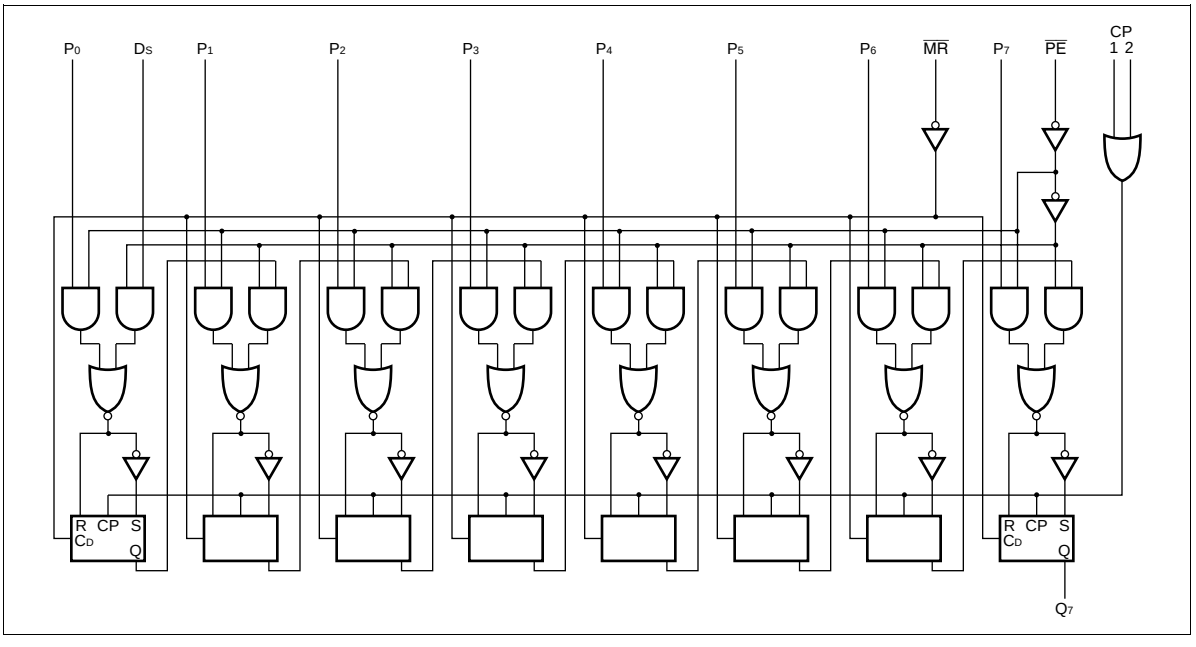
Truth Table

Inputs

					Parallel	Internal Outputs		Output
$\overline{MR}$	$\overline{PE}$	CP_2	CP_1	D_S	P_0 to P_7	Q_0	Q_6	Q_7
L	X	X	X	X	X	L	L	L
H	X	L	L	X	X	Q_{A0}	Q_{B0}	Q_{H0}
H	L	L	⎍	X	a ··· h	a	b	h
H	H	L	⎍	H	X	H	Q_{An}	Q_{Gn}
H	H	L	⎍	L	X	L	Q_{An}	Q_{Gn}
H	X	H	⎍	X	X	Q_{A0}	Q_{B0}	Q_{H0}

H : High Voltage Level
L : Low Voltage Level
X : Immaterial
⎍ : Low-to-High Clock Transition

Logic Diagram



DC Characteristics (unless otherwise specified)

Item	Symbol	Max	Unit	Condition
Maximum quiescent supply current	I_{CC}	80	µA	V_{IN} = V_{CC} or ground, V_{CC} = 5.5 V, Ta = Worst case
Maximum quiescent supply current	I_{CC}	8.0	µA	V_{IN} = V_{CC} or ground, V_{CC} = 5.5 V, Ta = 25°C
Maximum additional I_{CC}/input (HD74ACT166)	I_{CCT}	1.5	mA	V_{IN} = V_{CC} – 2.1 V, V_{CC} = 5.5 V, Ta = Worst case

AC Characteristics: HD74AC166

			Ta = +25°C, C_L = 50 pF			Ta = –40°C to +85°C, C_L = 50 pF		
Item	**Symbol**	**V_{CC} (V)*[1]**	**Min**	**Typ**	**Max**	**Min**	**Max**	**Unit**
Maximum clock	f_{max}	3.3	75	—	—	65	—	MHz
frequency		5.0	100	—	—	80	—	
Propagation delay	t_{PLH}	3.3	1.0	11.0	14.5	1.0	15.5	ns
CP_1 or CP_2 to Q_7		5.0	1.0	9.5	11.5	1.0	12.5	
Propagation delay	t_{PHL}	3.3	1.0	10.5	14.0	1.0	15.0	
CP_1 or CP_2 to Q_7		5.0	1.0	9.0	11.0	1.0	12.0	
Propagation delay	t_{PHL}	3.3	1.0	9.5	12.0	1.0	13.0	
$\overline{MR}$ to Q_7		5.0	1.0	6.5	9.0	1.0	10.0	

Note: 1. Voltage Range 3.3 is 3.3 V ± 0.3 V
Voltage Range 5.0 is 5.0 V ± 0.5 V

AC Operating Requirements: HD74AC166

Item	Symbol	V_{CC} (V)*[1]	Ta = +25°C C_L = 50 pF	Ta = –40°C to +85°C C_L = 50 pF		Unit
			Typ	Guaranteed Minimum		
Setup time	t_{su}	3.3	3.0	5.5	6.0	ns
$\overline{PE}$ or P_n or D_S to CP_n		5.0	2.0	4.0	4.5	
Hold time	t_h	3.3	–1.5	3.0	3.0	
CP_n to $\overline{PE}$ or P_n or D_S		5.0	–0.5	3.0	3.0	
Pulse width	t_w	3.3	2.0	5.5	7.0	
CP_n or $\overline{MR}$		5.0	2.0	4.5	5.0	
Recovery time	t_{rec}	3.3	–2.5	0.0	0.0	
$\overline{MR}$ to CP_n		5.0	–1.5	0.0	0.0	

Note: 1. Voltage Range 3.3 is 3.3 V ± 0.3 V
Voltage Range 5.0 is 5.0 V ± 0.5 V

AC Characteristics: HD74ACT166

Item	Symbol	V_{CC} (V)*[1]	Ta = +25°C C_L = 50 pF			Ta = –40°C to +85°C C_L = 50 pF		Unit
			Min	Typ	Max	Min	Max	
Maximum clock frequency	f_{max}	5.0	100	—	—	80	—	MHz
Propagation delay CP_n to Q_7	t_{PLH}	5.0	1.0	10.0	12.5	1.0	13.5	ns
Propagation delay CP_n to Q_7	t_{PHL}	5.0	1.0	9.5	12.0	1.0	13.0	
Propagation delay $\overline{MR}$ to Q_7	t_{PHL}	5.0	1.0	8.5	11.0	1.0	12.0	

Note: 1. Voltage Range 5.0 is 5.0 V ± 0.5 V

AC Operating Requirements: HD74ACT166

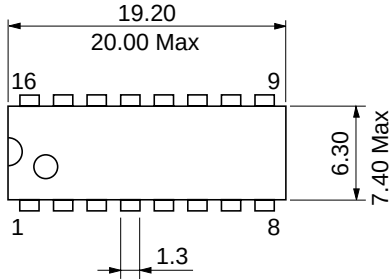
			Ta = +25°C C_L = 50 pF	Ta = –40°C to +85°C C_L = 50 pF		
Item	**Symbol**	**V_{CC} (V)*[1]**	**Typ**	**Guaranteed Minimum**		**Unit**
Setup time $\overline{PE}$ or P_n or D_S to CP_n	t_{su}	5.0	2.5	7.0	8.0	ns
Hold time CP_n to $\overline{PE}$ or P_n or D_S	t_h	5.0	0.0	1.5	1.5	
Pulse width CP_n or $\overline{MR}$	t_w	5.0	4.5	7.0	8.0	
Recovery time $\overline{MR}$ to CP_n	t_{rec}	5.0	–2.5	0.5	0.5	

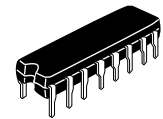
Note: 1. Voltage Range 5.0 is 5.0 V ± 0.5 V

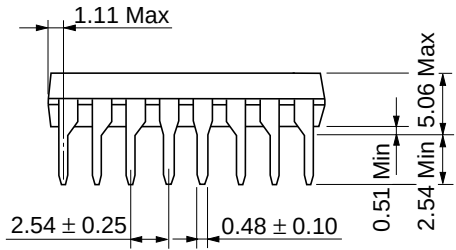
Capacitance

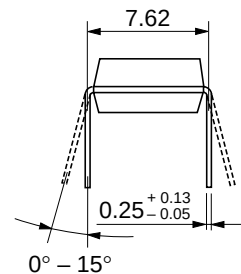
Item	**Symbol**	**Typ**	**Unit**	**Condition**
Input capacitance	C_{IN}	4.5	pF	V_{CC} = 5.5 V
Power dissipation capacitance	C_{PD}	35.0	pF	V_{CC} = 5.0 V

Unit: mm



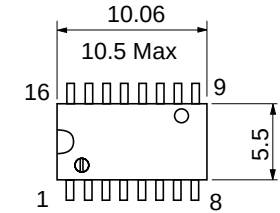


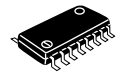


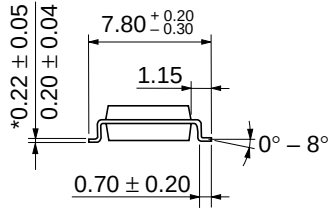


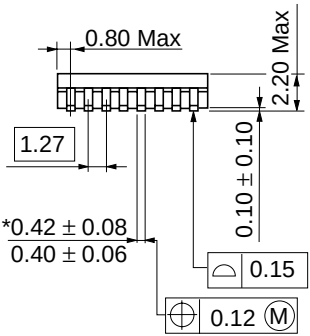
Hitachi Code	DP-16
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.07 g

Unit: mm





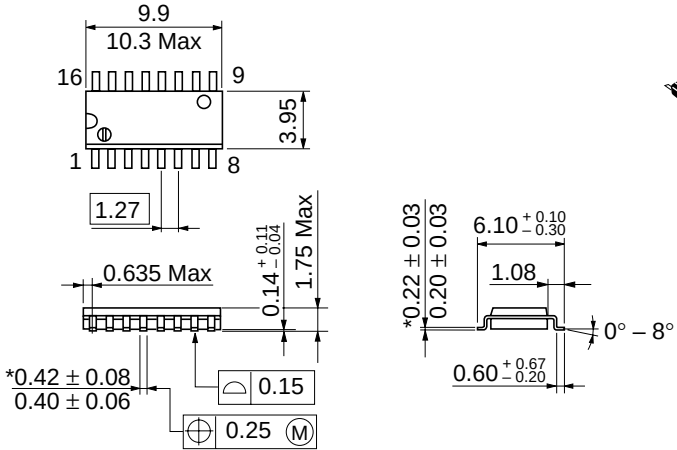


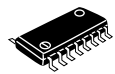


*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.24 g

Unit: mm

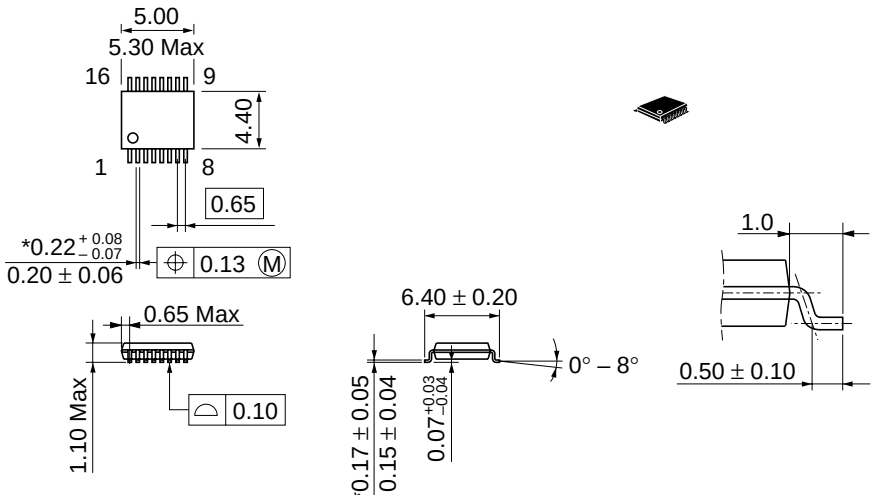




Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g

*Dimension including the plating thickness
Base material dimension

Unit: mm



Hitachi Code	TTP-16DA
JEDEC	—
EIAJ	—
Weight (reference value)	0.05 g

*Dimension including the plating thickness
Base material dimension

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HITACHI

Hitachi, Ltd.
Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

URL
NorthAmerica : http:semiconductor.hitachi.com/
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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose,CA 95134
Tel: <1> (408) 433-1990
Fax: <1>(408) 433-0223

Hitachi Europe GmbH
Electronic components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building. No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX